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FDC2512

150V N-Channel PowerTrench[®] MOSFET

General Description

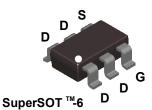
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

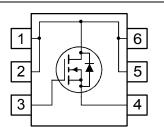
Applications

DC/DC converter

Features

- 1.4 A, 150 V. $R_{DS(ON)} = 425 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 475 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low gate charge (8nC typ)
- High power and current handling capability
- Fast switching speed





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		150	V
V _{GSS}	Gate-Source Voltage		± 20	V
I _D	Drain Current – Continuous	(Note 1a)	1.4	
	– Pulsed		8	A
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	13.5	mJ
PD	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T _J , T _{stg}	Operating and Storage Junction Temp	erature Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.252	FDC2512	7"	8mm	3000 units

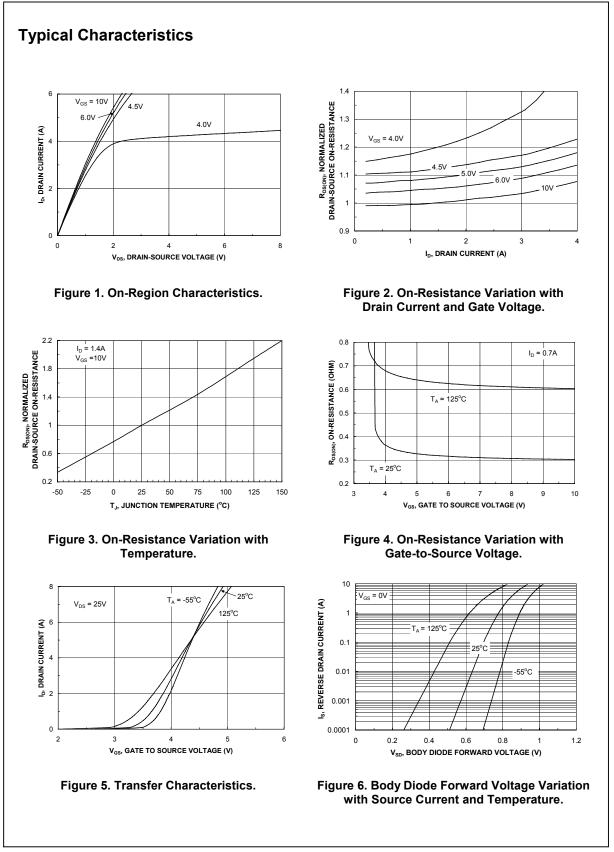
Semiconductor Components Industries, LLC, 2017 March, 2017, Rev. 1.4

BV _{DSS} <u>ABV_{DSS}</u> <u>A</u> T _J DSS	acteristics Drain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient			Тур	Max	Units
BV _{DSS} ΔBV _{DSS} ΔTJ DSS GSSF GSSR	Drain–Source Breakdown Voltage Breakdown Voltage Temperature					
ΔTJ DSS GSSF GSSR		$V_{GS} = 0 V$, $I_D = 250 \mu A$	150			V
DSS GSSF GSSR		$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		147		mV/°C
GSSF GSSR	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
GSSR	Gate–Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	Gate-Body Leakage, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$			-100	nA
	acteristics (Note 2)		1			1
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.6	4	V
∆VGS(th)	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-5.6		mV/°C
R _{DS(on)}	Static Drain–Source On Resistance			319 332 624	425 475 875	mΩ
D(on)	On–State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	4			Α
FS	Forward Transconductance	$V_{DS} = 10 V$, $I_{D} = 1.4 A$		4		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 75 V$, $V_{GS} = 0 V$,		344		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		22		pF
C _{rss}	Reverse Transfer Capacitance	_		9		pF
Rg	Gate Resistance		0.1	1.4	3.0	Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Ig Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time	V_{DD} = 75 V, I_D = 1 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		6.5 3.5	13 7	ns
t _{d(on)} t _r	Turn–On Delay Time				-	-
t _{d(on)} tr t _{d(off)}	Turn–On Delay Time Turn–On Rise Time			3.5	7	ns
t _{d(on)} tr t _{d(off)} t _f	Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		3.5 22	7 33	ns ns
t _{d(on)} tr t _{d(off)} t _f Q _g	Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		3.5 22 4	7 33 8	ns ns ns
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{DS} = 75 \text{ V}, I_D = 1.4 \text{ A},$		3.5 22 4 8	7 33 8	ns ns ns nC
td(on) tr td(off) tf Qg Qgs Qgs Qgd	Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 75 \text{ V}, \qquad I_D = 1.4 \text{ A},$ $V_{GS} = 10 \text{ V}$		3.5 22 4 8 1.5	7 33 8	ns ns nC nC
t _{d(on)} tr	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 75 \text{ V}, \qquad I_D = 1.4 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings		3.5 22 4 8 1.5	7 33 8	ns ns nC nC
t _{d(on)} tr t _{d(off)} t _f Q _g Q _g Q _{gd} Drain–Sc s	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Durce Diode Characteristics	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 75 \text{ V}, \qquad I_D = 1.4 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings		3.5 22 4 8 1.5	7 33 8 11	ns ns nC nC nC
t _{d(on)} tr tr Qg Qgs Qgd Drain–Sc S V _{SD}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Durce Diode Characteristics Maximum Continuous Drain-Source Drain-Source Diode Forward	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{DS} = 75 \text{ V}, I_D = 1.4 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings e Diode Forward Current		3.5 22 4 8 1.5 2.3	7 33 8 11 1.3	ns ns nC nC nC A

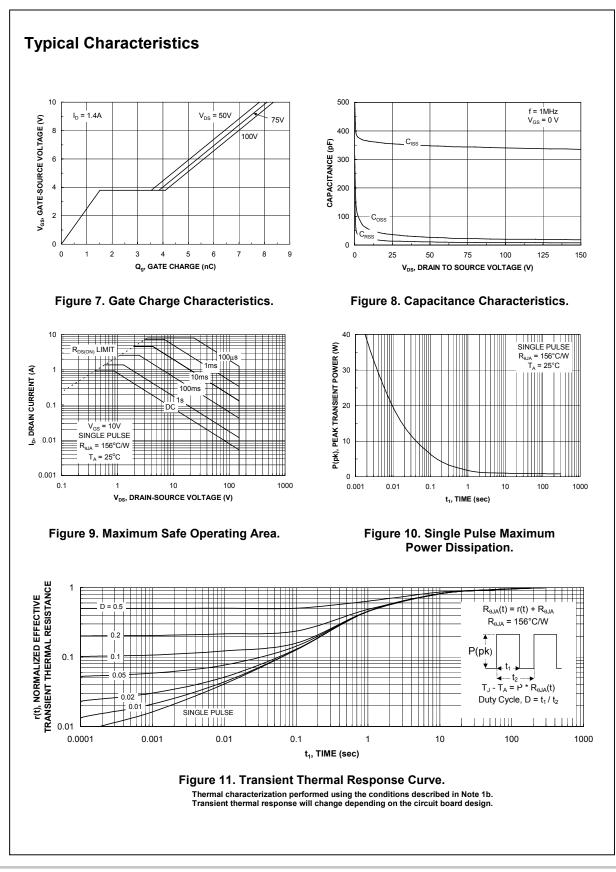
FDC2512

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

3. E_{AS} of 13.5 mJ is based on starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 3 A, V_{DD} = 150 V, V_{GS} = 10 V.

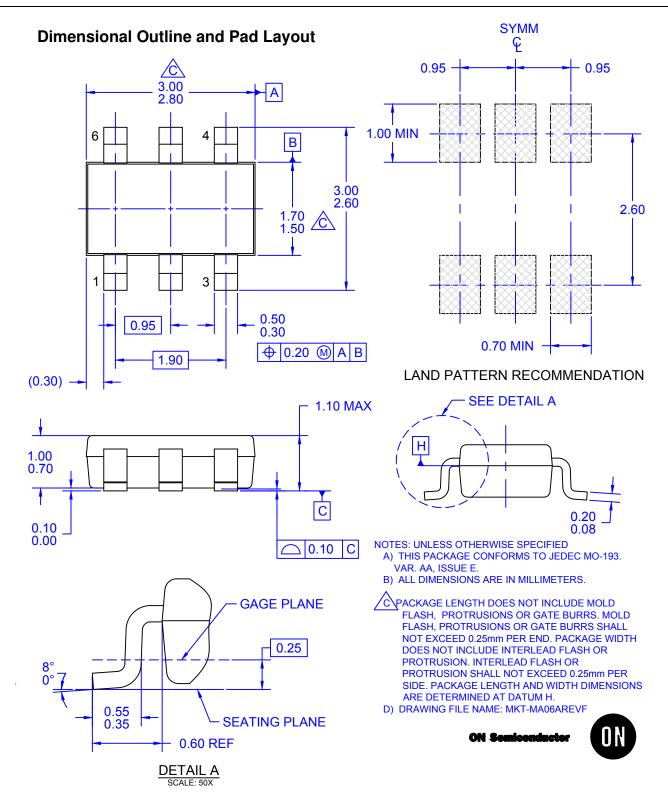


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